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ABSTRACT

FLATTENING POLISHING DEVICE AND FLATTENING POLISHING METHOD

The flattening polishing device and method of the present invention is provided with first polishing means and second polishing means disposed coaxially, moving means for moving the respective polishing means relative to each other in an axial direction and rotary means for rotating the respective polishing means around a shaft, thus enabling flattening and polishing with high accuracy and no defects.

(FIG. 1)